

ACADEMIC APPLICATION FOR ADMISSION TO STUDY [2019]

- □ COMPLETE ALL SECTIONS IN INK AND RETURN TO THE INNOVATION PARK
 BUILDING AT PHOCWENI. (NEXT TO ARMY BARRACKS)
- ATTACH CERTIFIED COPIES OF ACADEMIC CERTIFICATES, INCLUDING NATIONAL IDENTITY DOCUMENT.
- **△** AN APPLICATION FEE OF E250 IS TO BE PAID ON SUBMISSION OF FORMS

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SECTION	N C: CHOICE OF STUDY			
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SECOND	CHOICE			
MOTIVA	TION (Why these programme	es)		
SECTION	N D: INFORMATION OF AP	PLICANT		
				(T; 1-)
A HIGH	SCHOOL LEAVER WHO H	IAS DONE O'LE	VEL/IGCSE/HIGCSE/SGCSE	(Tick)
A HIGH	SCHOLL LEAVER WHO H	AS DONE SOUT	TH AFRICAN SENIOR CERTIFICATE	
A HIGH	SCHOOL LEAVER WHO H	IAS DONE 'A' L	EVEL/EQUIVALENT	
A CANE	DIDATE WHO HAS A POST	HIGH SCHOOL	PROFESSIONAL QUALIFICATION	
1. PO	ST HIGH SCHOOL INSTITU	JTIONS ATTEN	DED (i.e. technikon, university, college e	etc)
		T	(
	NAME OF INSTITUTION	DURATION OF STUDY	QUALIFICATION	



SECTION E: FINANCIAL INFORMATION

SURETY (PLEASE READ CAREFULLY)

TITLE, MD/MDC/MICC (Tiple and)

I THE SIGNATORY (HEREIN REFERRED TO AS THE 'SURETY') TO THIS APPLICATION, OTHER THAN THE STUDENT, HEREBY BIND MYSELF AS SURETY & CO-PRINCIPAL DEBTOR JOINTLY & SEVERALLY FOR & WITH THE STUDENT (THE PRINCIPAL DEBTOR) IN FAVOUR OF THE ADVANCED SCHOOL OF INFORMATION TECHNOLOGY, FOR THE PAYMENT OF ALL DEBTS & DUE FULFILMENT OF ALL OBLIGATIONS OF WHATEVER NATURE & HOWEVER ARISING WHICH THE STUDENT MAY NOW OR HEREAFTER OWE TO THE ADVANCED SCHOOL OF INFORMATION TECHNOLOGY.

I UNDERTAKE NOT TO INSTITUTE ANY CLAIM AGAINST THE INSTITUTION ON ACCOUNT OF ANY INJURIES OR LOSS SUFFERED OR ILLNESS CONTRACTED BY THE APPLICANT DURING THE COURSE OF OR ARISING DURING HIS/HER STUDIES AT THE INSTITUTION. I AGREE THAT THE INSTI-TUTION, THROUGH ITS ENDORSEMENT BY THE SWAZILAND HIGHER EDUCATION COUNCIL MAY AMEND ANY REGULATIONS, POLICY, OR PROCEDURE AND THAT I SHALL BE BOUND TO ANY SUCH AMENDMENTS. I SUBMITTHAT ALL INFORMATION CONTAINED HEREIN IS TRUE & CORRECT TO MY KNOWLEDGE.

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SECTION F: N	SECTION F: MATERIALS CHECKLIST																							
TO BE COM	ИРLЕТ	ED	BY	ASI	T S	ГАБ	F													(Tic	k)		
COMPLETED	ALL	SEC	CTIC	ONS																				
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CERTIFIED C	CERTIFIED COPIES OF ACADEMIC CERTIFICATES																_				_			
CERTIFIED C	CERTIFIED COPY OF PROOF OF PAYMENT																							